

Francis Gold Sy

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EDUCATION

City University of New York, City College

Expected Grad: *June 2022*

Major: B.E., Mechanical Engineering; Minor: Computer Science

GPA: 3.86

Relevant Coursework: Computer-Aided Design, Mechanical Systems Design, Fundamentals of Mechatronics

PROFESSIONAL SKILLS

Software: SolidWorks, Autodesk Fusion 360, MATLAB, Arduino, Java, Python, Gazebo, R.O.S.

Manufacturing: FDM & SLA 3D Printers, Laser Cutter, Prototyping, Design for Manufacturing

EXPERIENCE

Biomechatronics and Intelligent Robotics Lab, CCNY

Oct 2020 – Present

Undergraduate Research Assistant

- Simulating different configurations of a servo-actuated foldable robot using Gazebo and R.O.S.
- Utilizing Gazebo and R.O.S. in an Ubuntu workspace with GitHub implemented into project workflow
- Programmed custom python scripts to enable keyboard control using Gazebo's Joint Position Controllers
- Created custom URDF file to make a parallel-configured robot model with fine-tuned physics parameters
- Created a python script that executes configuration animations using Rviz – a R.O.S. 3D visualization tool
- Experimented with MATLAB's Robotics System Toolbox to construct and control joints

WearWorks Inc, NYC

Mechanical Engineering Intern

June 2020 – Aug 2020

- Collaborated in a team of three to design, iterate, and prototype a haptic smartwatch for manufacturing
- Reduced manufacturing costs by integrating design feedback from injection molding companies
- Conducted plastics and stress simulations in SolidWorks to optimize product for manufacturing
- Managed DFMEA, PFMEA, process flow chart, and other manufacturing-related documents
- Identified and communicated with promising U.S. and overseas suppliers for B.O.M. needs
- Ideated and modeled different versions of packaging for company product

Engineering Intern

Jan 2020 – Feb 2020

- Lead development and production of the WayBand for showcasing events and projected product launch
- Soldered, assembled, and applied surface-finishing techniques for Wayband production
- Operated and maintained the Form 2 for product iterations and development

Zahn Innovation Center, CCNY

Feb 2019 – May 2020

Engineering Apprentice

- Using SolidWorks, Fusion 360, 3D printers, and laser cutter for various projects and design applications
- Executed design of various client-requested products through small team collaboration
- Experienced in the use and maintenance of FDM and SLA 3D printers
- Designed, iterated, and delivered a multi-accessory K-8 mathematical learning apparatus to an outside client

DogSpot Inc, NYC

June 2019 – Aug 2019

Engineering Intern

- Supported circuit board production through wire prep, soldering, and board assembly
- Managed circuit board materials and maintained hardware inventory
- Streamlined circuit board production through documentation of assembly and troubleshooting processes
- Maintained strong communication with assembly team to ensure deadline completion and smooth workflow

PROJECTS

Customized PCB Keychains

August 2019

- Used Autodesk Fusion 360 to create a two-part keychain casing using a snap-fit mechanism; included company logo on front and font-customized names on the back
- Soldered LEDs, wires, battery mount, and button onto circuit boards; installed boards into 3D printed casing

ACCOMPLISHMENTS

- September 2019: S Jay Levy Fellow – a selective year-long professional development experience
- March 2019: Mark Zemansky Introductory Physics Prize Winner